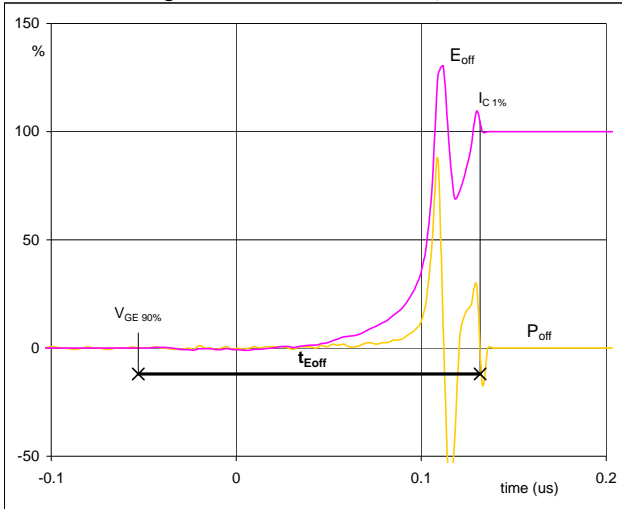


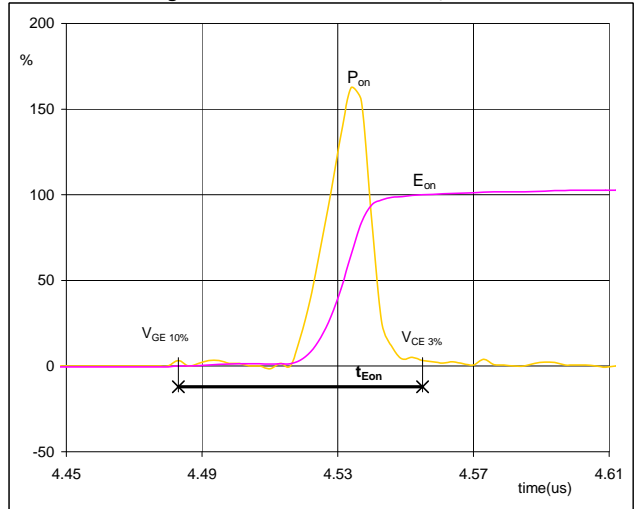
Switching Definitions H-Bridge MOSFET

Figure 5 H-Bridge MOSFET

Turn-off Switching Waveforms & definition of t_{Eoff}


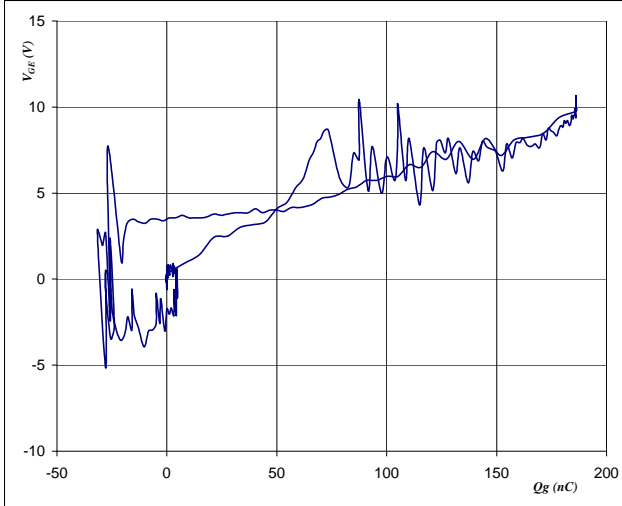
$P_{off} (100\%) =$	12.15	kW
$E_{off} (100\%) =$	0.05	mJ
$t_{Eoff} =$	0.18	μ s

Figure 6 H-Bridge MOSFET

Turn-on Switching Waveforms & definition of t_{Eon}


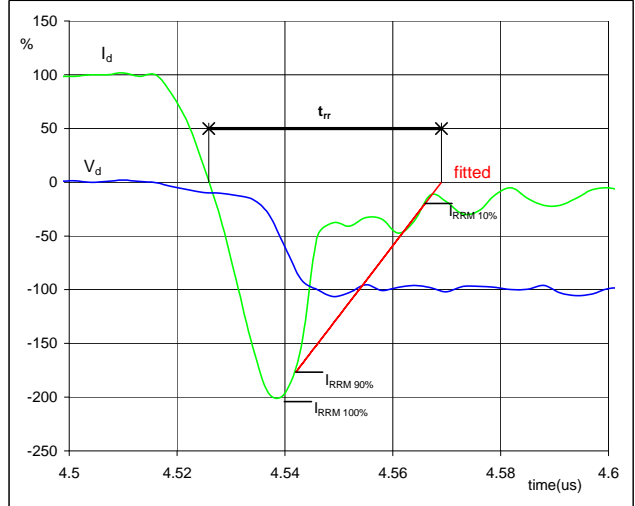
$P_{on} (100\%) =$	12.15	kW
$E_{on} (100\%) =$	0.31	mJ
$t_{Eon} =$	0.07	μ s

Figure 7 H-Bridge MOSFET

Gate voltage vs Gate charge (measured)


$V_{GEoff} =$	0	V
$V_{GEon} =$	10	V
$V_C (100\%) =$	400	V
$I_C (100\%) =$	30	A
$Q_g =$	186.04	nC

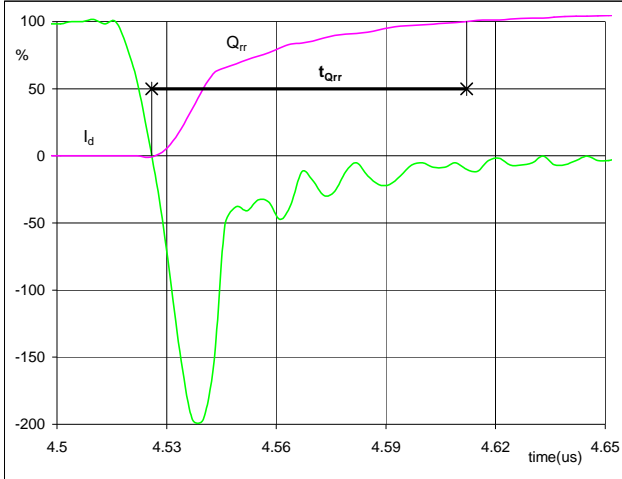
Figure 8 H-Bridge FWD

Turn-off Switching Waveforms & definition of t_{rr}


$V_d (100\%) =$	400	V
$I_d (100\%) =$	30	A
$I_{RRM} (100\%) =$	-61	A
$t_{rr} =$	0.04	μ s

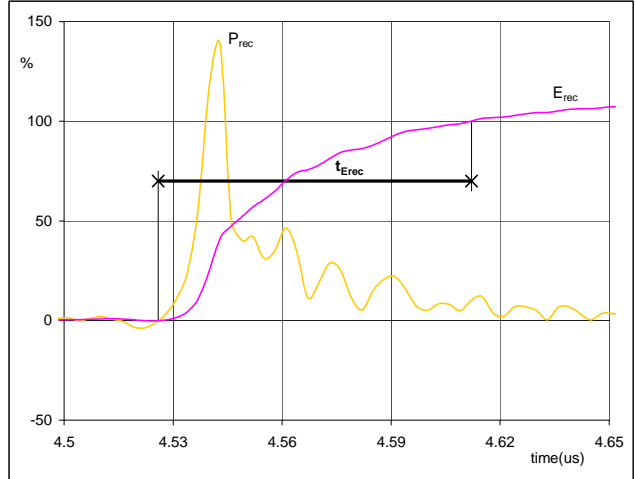
Switching Definitions H-Bridge MOSFET

Figure 9 H-Bridge FWD

Turn-on Switching Waveforms & definition of t_{Qrr}
 (t_{Qrr} = integrating time for Q_{rr})


I_d (100%) =	30	A
Q_{rr} (100%) =	1.29	μC
t_{Qrr} =	0.09	μs

Figure 10 H-Bridge FWD

Turn-on Switching Waveforms & definition of t_{Erec}
 (t_{Erec} = integrating time for E_{rec})


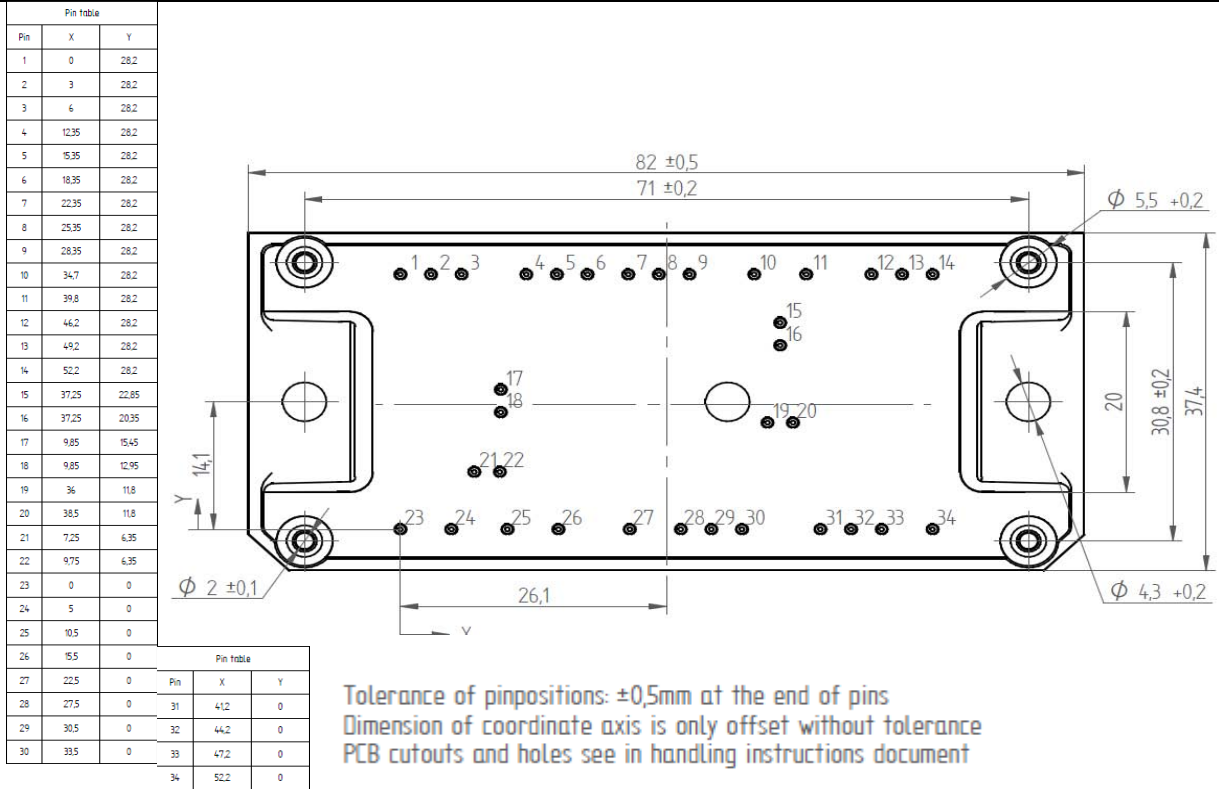
P_{rec} (100%) =	12.15	kW
E_{rec} (100%) =	0.35	mJ
t_{Erec} =	0.09	μs

Ordering Code and Marking - Outline - Pinout

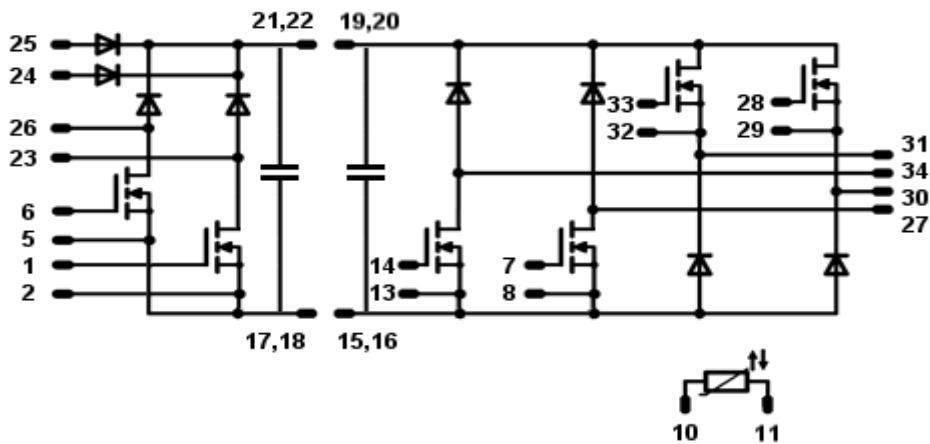
Ordering Code & Marking

Version	Ordering Code	in DataMatrix as	in packaging barcode as
without thermal paste 12mm housing	10-FY07BIA041MF-M528E68	M528E68	M528E68

Outline



Pinout



Pins 3,4,9,12 are not connected.

PRODUCT STATUS DEFINITIONS

Datasheet Status	Product Status	Definition
Target	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. The data contained is exclusively intended for technically trained staff.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data may be published at a later date. Vincotech reserves the right to make changes at any time without notice in order to improve design. The data contained is exclusively intended for technically trained staff.
Final	Full Production	This datasheet contains final specifications. Vincotech reserves the right to make changes at any time without notice in order to improve design. The data contained is exclusively intended for technically trained staff.

DISCLAIMER

The information given in this datasheet describes the type of component and does not represent assured characteristics. For tested values please contact Vincotech. Vincotech reserves the right to make changes without further notice to any products herein to improve reliability, function or design. Vincotech does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, nor the rights of others.

LIFE SUPPORT POLICY

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.